

TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOSII)

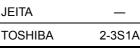
# SSM3J14T

Power Management Switch DC-DC Converters

- Suitable for high-density mounting due to compact package
- Low on Resistance:  $R_{on} = 145 \text{ m}\Omega \text{ (max)} (@V_{GS} = -4.5 \text{ V})$ 
  - $R_{on} = 85 \text{ m}\Omega \text{ (max)} (@V_{GS} = -10 \text{ V})$
- High-speed switching

#### Maximum Ratings (Ta = 25°C)

Characteristics		Symbol		Rating	Unit	
Drain-Source voltage		V <sub>DS</sub>		-30	V	
Gate-Source voltage		V <sub>GSS</sub>		±20	V	
Drain current	DC		ID	-2.7		
	Pulse	I <sub>DP</sub> (Note 2)		-5.4	A	
Drain power dissipation		PD	t = 10 s	1.25	W	
			(Note 1)	0.7		
Channel temperature		T <sub>ch</sub>		150	°C	
Storage temperature range		T <sub>stg</sub>		–55 to 150	°C	

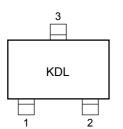


Weight: 10 mg (typ.)

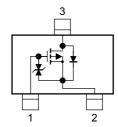
Note 1: Mounted on FR4 board (25.4 mm  $\times$  25.4 mm  $\times$  1.6 t, Cu pad: 645 mm²)

Note 2: The pulse width limited by maximum channel temperature.

#### Marking



### **Equivalent Circuit**



## **Handling Precaution**

When handling individual devices (which are not yet mounted on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

The Channel-to-Ambient thermal resistance  $R_{th}$  (ch-a) and the drain power dissipation  $P_D$  vary according to the board material, board area, board thickness and pad area, and are also affected by the environment in which the product is used. When using this device, please take heat dissipation fully into account

Unit: mm

0.4±0.1

0.16±0.05

2.8<sup>+0.2</sup> 1.6<sup>+0.2</sup> -0.1

> 1. GATE 2. SOURCE 3. DRAIN

> > \_\_\_\_

0 95

.95

2.9±0.2

7±0.

TSM

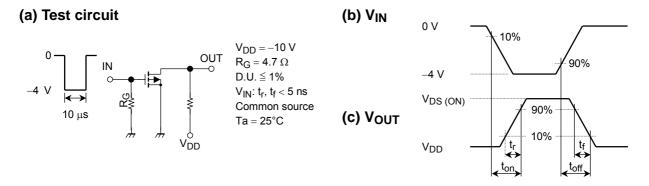
JEDEC

**Electrical Characteristics (Ta = 25°C)** 

Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage current		I <sub>GSS</sub>	$V_{GS}=\pm 16~V,~V_{DS}=0$	_		±1	μA	
Drain-source breakdown voltage		V (BR) DSS	$I_D = -1 \text{ mA}, V_{GS} = 0$	-30	_	_	V	
		V (BR) DSX	$I_D = -1$ mA, $V_{GS} = 20$ V	-15	_	_	V	
Drain cut-off current		I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0$		_	-1	μ <b>A</b>	
Gate threshold voltage		V <sub>th</sub>	$V_{DS} = -5 \text{ V}, \text{ I}_{D} = -0.1 \text{ mA}$	-0.8	_	-2.0	V	
Forward transfer admittance		Y <sub>fs</sub>	$V_{DS} = -5 \text{ V}, \text{ I}_{D} = -1.35 \text{ A}$ (Note 3)	2.0			S	
Drain-source on resistance		R <sub>DS (ON)</sub>	$I_D = -1.35 \text{ A}, V_{GS} = -10 \text{ V}$ (Note 3)		63	85		
			$I_D = -1.35 \text{ A}, V_{GS} = -4.5 \text{ V}$ (Note 3)		106	145	mΩ	
			$I_D = -1.35 \text{ A}, V_{GS} = -4.0 \text{ V}$ (Note 3)		120	170		
Input capacitance		C <sub>iss</sub>	$V_{DS} = -15 \text{ V}, \text{ V}_{GS} = 0, \text{ f} = 1 \text{ MHz}$		413		pF	
Reverse transfer capacitance		C <sub>rss</sub>	$V_{DS} = -15 \text{ V}, \text{ V}_{GS} = 0, \text{ f} = 1 \text{ MHz}$		77		pF	
Output capacitance		C <sub>oss</sub>	$V_{DS} = -15 \text{ V}, \text{ V}_{GS} = 0, \text{ f} = 1 \text{ MHz}$		113		pF	
Switching time	Turn-on time	t <sub>on</sub>	$V_{DD} = -15 \text{ V}, \text{ I}_{D} = -1 \text{ A}$		29		ns	
	Turn-off time	t <sub>off</sub>	$V_{GS} = 0$ ~-4 V, $R_{G} = 10 \Omega$		29			

Note 3: Pulse test

### **Switching Time Test Circuit**



### Precaution

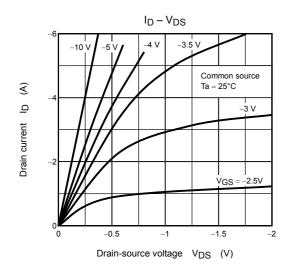
 $V_{th}$  can be expressed as voltage between gate and source when low operating current value is  $I_D$  =  $-100~\mu A$  for this product. For normal switching operation,  $V_{GS}$  (on) requires higher voltage than  $V_{th}$  and  $V_{GS}$  (off) requires lower voltage than  $V_{th}$ .

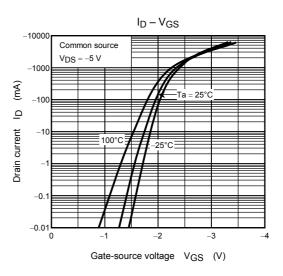
(relationship can be established as follows:  $V_{GS}$  (off) <  $V_{th}$  <  $V_{GS}$  (on))

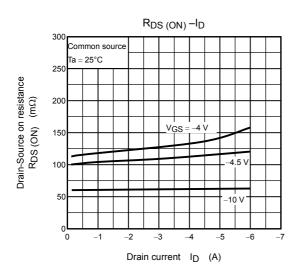
Please take this into consideration for using the device.

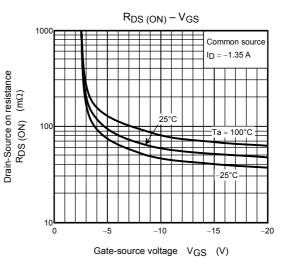
 $V_{GS}$  recommended voltage of -4 V or higher to turn on this product.

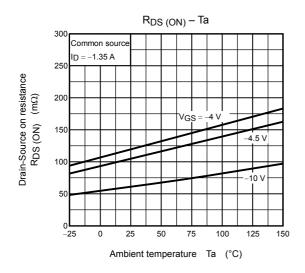
# TOSHIBA



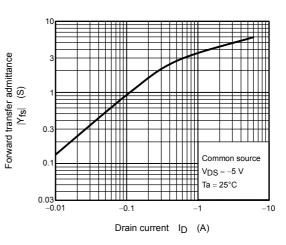




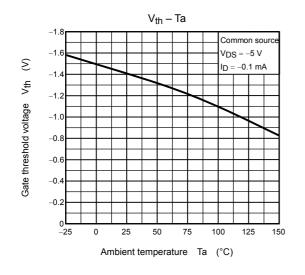


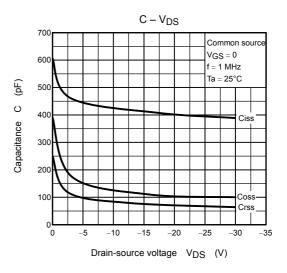


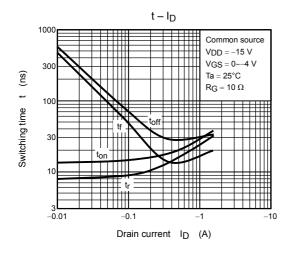
 $|Y_{fs}| - I_D$ 

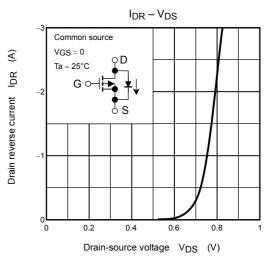


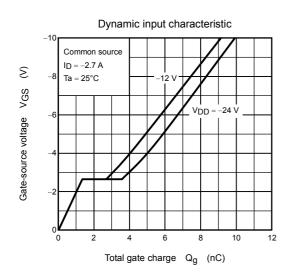
## **TOSHIBA**

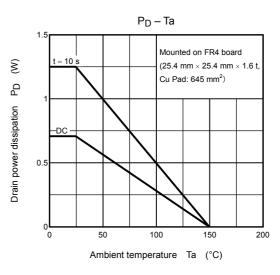


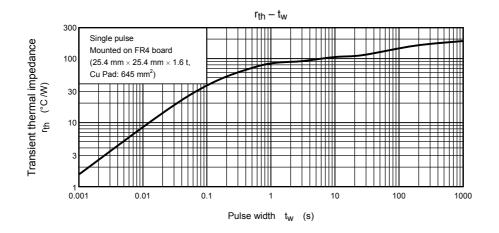


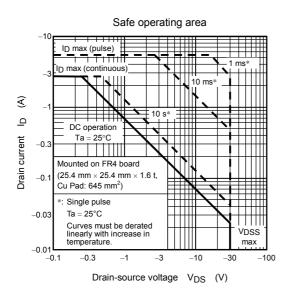












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